505077032 09/04/2018

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5123789

SUBMISSION TYPE:		NEW ASSIGNMENT	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:		ASSIGNMENT	ASSIGNMENT		
CONVEYING PARTY	DATA				
		Name	Execution Date		
MAKAR SNAI			08/03/2018		
EHAB ABDEL GHANY	/		08/29/2018		
MANOHAR SEETHAF	AM		08/03/2018		
LI-CHUNG CHANG			08/03/2018		
RECEIVING PARTY D	ΑΤΑ				
Name:					
Street Address:	5775 M	5775 MOREHOUSE DRIVE			
City:	SAN DIE	SAN DIEGO			
State/Country:	CALIFO	CALIFORNIA			
Postal Code:	92121-1	92121-1714			
PROPERTY NUMBERS Total: 1 Property Type					
		Number			
	e	Number 16030658			
Property Type Application Number: CORRESPONDENCE Fax Number: <i>Correspondence will</i>	e 1 DATA be sent to if provided; e: (ot via US Mail.		
Property Type Application Number: CORRESPONDENCE Fax Number: Correspondence will using a fax number, i Email: Correspondent Name Address Line 1:	e 1 DATA be sent to if provided; e: (the e-mail address first; if that is uns ; if that is unsuccessful, it will be sen Fodd@colbynipper.com QUALCOMM INCORPORATED 5775 MOREHOUSE DRIVE	ot via US Mail.		
Property Type Application Number: CORRESPONDENCE Fax Number: Correspondence will using a fax number, i Email: Correspondent Name Address Line 1: Address Line 4:	e 1 DATA be sent to if provided; e: (5 NUMBER:	the e-mail address first; if that is uns ; if that is unsuccessful, it will be sen Fodd@colbynipper.com QUALCOMM INCORPORATED 5775 MOREHOUSE DRIVE SAN DIEGO, CALIFORNIA 92121-1714	ot via US Mail.		
Property Type Application Number: CORRESPONDENCE Fax Number: Correspondence will using a fax number, i Email: Correspondent Name Address Line 1: Address Line 4:	e 1 DATA be sent to if provided; e: (5 NUMBER:	the e-mail address first; if that is uns ; if that is unsuccessful, it will be sen Fodd@colbynipper.com QUALCOMM INCORPORATED 5775 MOREHOUSE DRIVE SAN DIEGO, CALIFORNIA 92121-1714 176780	ot via US Mail.		
Property Type Application Number: CORRESPONDENCE Fax Number: Correspondence will using a fax number, I Email: Correspondent Name Address Line 1: Address Line 4: ATTORNEY DOCKET I	e 1 DATA be sent to if provided; e: (5 NUMBER:	the e-mail address first; if that is uns ; if that is unsuccessful, it will be sen Fodd@colbynipper.com QUALCOMM INCORPORATED 5775 MOREHOUSE DRIVE SAN DIEGO, CALIFORNIA 92121-1714 176780 KEITH W. SAUNDERS	ot via US Mail.		

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PATENT QUALCOMM Ref. No. 176780 Page 1 of 3

ASSIGNMENT

WHEREAS, WE,

1. Makar SNAI, a citizen of India, having a mailing address located at 5775 Morehouse Drive San Diego, CA 92121 and a resident of Burdwan, India,

2. Ehab ABDEL GHANY, a citizen of Egypt, having a mailing address located at 5775 Morehouse Drive San Diego, CA 92121 and a resident of San Diego, CA,

3. Manohar SEETHARAM, a citizen of India, having a mailing address located at 5775 Morehouse Drive San Diego, CA 92121 and a resident of Bangalore, India,

4. Li-chung CHANG, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive San Diego, CA 92121 and a resident of Irvine, CA,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to AMPLIFICATION WITH POST-DISTORTION COMPENSATION (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, Qualcomm Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 16/030,658 filed July 9, 2018, Qualcomm Reference No. 176780, and all provisional applications relating thereto, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

PATENT REEL: 046781 FRAME: 0991 AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

PATENT QUALCOMM Ref. No. 176780 Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _	Bangalone, o	n <u>3/8/201</u> 8 DATE	Makar Shou"
Done at	LOCATION	n DATE	Ehab ABDEL GHANY
Done at	BANGALORE, C	n <u>3/ 8/2018</u> DATE	S. Manoha Manohar SEETHARAM
Done at _	LOCATION	n DATE	Li-chung CHANG

PATENT QUALCOMM Ref. No. 176780 Page 1 of 3

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PATENT REEL: 046781 FRAME: 0994 AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

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AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

PATENT QUALCOMM Ref. No. 176780 Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	, on	
LOCATION	DATE	Makar SNAI
Done at <u>LOCATION</u>	, on <u>8/29/24</u> 5 DATE	Ehab ABDEL GHANY
Done at LOCATION	, on DATE	Manohar SEETHARAM
Done at LOCATION	, on DATE	Li-chung CHANG

PATENT QUALCOMM Ref. No. 176780 Page 1 of 3

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PATENT REEL: 046781 FRAME: 0997 AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any be granted hereafter for said INVENTIONS in any be granted hereafter for said INVENTIONS in applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

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Done at		, on		
]	LOCATION		DATE	Makar SNAI
Done at	LOCATION	on	DATE	Ehab ABDEL GHANY
Done at	LOCATION	_ on _	DATE	Manohar SEETHARAM
Done at	<u>A (Xeq 5)</u> LOCATI <mark>DN</mark>	_, on	<u> </u>	TJ-chung CHANG

a)